## CCD VERTICAL DRIVER FOR DIGITAL CAMERAS

## FEATURES

- CCD Vertical Driver:
- Three Field CCD Support
- Two Field CCD Support
- Output Drivers:
- 3 Levels Driver (V-Transfer) x 5
- 2 Levels Driver (V-Transfer) x 3
- 2 Levels Driver (E-Shutter) x 1
- Drive Capability:
- 450 pF to 1890 pF With $60 \Omega$ to $240 \Omega$
- Input Phase:
- 3 State (V-Transfer) x 5
- 2 State (V-Transfer) $\times 3$
- 2 State (E-Shutter) x 1
- Portable Operation:
- Input Interface: 2.7 V to 5.5 V
- Power Supply:
- VDD
- VL
- VM
2.7 V to 5.5 V
- VH
-5 V to -9 V
GND
11.5V to 15.5 V


## APPLICATIONS

- Digital Camera
- Video Camera


## DESCRIPTION

The VSP1900 is a CCD vertical clock driver with electricshutter support. This device is composed of eight vertical transfer channels, which support both 3-field CCD and 2 -field CCD operation. The VSP1900 contributes low power consumption and parts number reduction in the system. storage or handling to prevent electrostatic damage to the MOS gates.

## ORDERING INFORMATION

| PRODUCT | PACKAGE | PACKAGE <br> DESIGNATOR | OPERATING <br> TEMPERATURE RANGE | PACKAGE <br> MARKING | ORDERING <br> NUMBER | TRANSPORT MEDIA |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| VSP1900 | TSSOP30 | DBT | $-25^{\circ} \mathrm{C}$ to $85^{\circ} \mathrm{C}$ | VSP1900 | VSP1900 | Tube ( 60 units/tube) |
|  | Tape and reel |  |  |  |  |  |

(1) For the most current specification and package information, refer to our web site at www.ti.com.

## ABSOLUTE MAXIMUM RATINGS

over operating free-air temperature range unless otherwise noted ${ }^{(1)}$

|  |  | UND |
| :--- | :--- | :---: |
| Supply voltage | VL |  |
|  | VL | $\mathrm{GND}-0.3 \mathrm{~V}$ to 7 V |
|  | VH | GND to -10 V |
| Input voltage, $\mathrm{V}_{\text {IN }}$ | $\mathrm{VL}+26 \mathrm{~V}$ |  |
| Ambient temperature underbias | $-25^{\circ} \mathrm{C}$ to $85^{\circ} \mathrm{C}$ |  |
| Storage temperature, $\mathrm{T}_{\text {stg }}$ | $-55^{\circ} \mathrm{C}$ to $150^{\circ} \mathrm{C}$ |  |
| Junctiontemperature | $150^{\circ} \mathrm{C}$ |  |
| Package temperature (IR reflow, peak) | $235^{\circ} \mathrm{C}$ |  |

(1) Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

## RECOMMENDED OPERATING CONDITIONS

free-airtemperature range unless otherwise noted

|  | MIN | NOM | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: |
| Supply voltage, VDD | 2.7 |  | 5.5 | V |
| Supply voltage, VL | -5 |  | -9 | V |
| Supply voltage, VH | 11.5 |  | 15.5 | V |
| Input voltage, VIN |  | $\begin{aligned} & \hline-0.3 \\ & 0 \\ & +0.3) \\ & \hline \end{aligned}$ |  | V |

## TRUTH TABLE

| INPUT |  |  |  | OUTPUT |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| V1N | CH1N |  |  | V1 |  |  |
| V3AN | CH2N |  |  | V3A |  |  |
| V3BN | CH3N | V2N |  | V3B | V2 |  |
| V5AN | CH 4 N | V4N |  | V5A | V4 |  |
| V5BN | CH5N | V6N | SUBN | V5B | V6 | SUB |
| L | L | X | X | VH | X | X |
| L | H | X | X | VM | X | X |
| H | L | X | X | Z | X | X |
| H | H | X | X | VL | X | X |
| X | X | L | X | X | VM | X |
| X | X | H | X | X | VL | X |
| X | X | X | L | X | X | VH |
| X | X | X | H | X | X | VL |

NOTE: $Z=$ High impedance $\quad X=$ Don't care

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## ELECTRICAL CHARACTERISTICS

all specifications at $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ (unless otherwise noted)

|  | PARAMETER | TEST CONDITIONS | MIN | TYP MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  | DC power consumption |  |  | 5.3 | mW |
|  | Switching power consumption | VSP2267 (TG) with loading diagram |  | 550 | mW |
| DC CHARACTERISTICS |  |  |  |  |  |
| $\mathrm{V}_{\text {IH }}$ | High-level input voltage |  | 0.7VDD |  | V |
| $\mathrm{V}_{\text {IL }}$ | Low-level input voltage |  |  | 0.2VDD | V |
| IN | Input current | $\mathrm{V}_{\text {IN }}=$ GND to 5 V (without pullup / pulldown resistor) | -10 | $0 \quad 10$ | $\mu \mathrm{A}$ |
|  |  | $\mathrm{V}_{\text {IN }}=$ GND to 5 V (pullup / pulldown resistor) | -625 | $0 \quad 625$ |  |
| $\mathrm{IH}^{\text {H }}$ | Operating supply current |  |  | 0.10 .2 | mA |
| IDD |  |  |  | 1 |  |
| LL |  |  |  | 0.125 |  |
| lOL | Output current | V1, V2, V3A, V3B, V4, V5A, V5B, V6 =-8.1 V | 10 |  | mA |
| IOM1 |  | V1, V2, V3A, V3B, V4, V5A, V5B, V6 =-0.2 V |  | -5 |  |
| IOM2 |  | V1, V3A, V3B, V5A, V5B = 0.2 V | 5 |  |  |
| IOH |  | V1, V3A, V3B, V5A, V5B $=14.55 \mathrm{~V}$ |  | -7.2 |  |
| IOSL |  | SUB $=-8.1 \mathrm{~V}$ | 5.4 |  |  |
| IOSH |  | SUB $=14.55 \mathrm{~V}$ |  | -4 |  |

## SWITCHING CHARACTERISTICS

all specifications at $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ (unless otherwise noted)


PIN ASSIGNMENTS


Terminal Functions

| TERMINAL |  | NAME | NO. |
| :--- | :---: | :---: | :--- |
| TYPE |  |  |  |
| GND | 1 | P | Ground |
| SUBN | 2 | DI | CCD substrate clock SUB input |
| V2N | 3 | DI | Vertical transfer clock 2 input |
| V4N | 4 | DI | Vertical transfer clock 4 input |
| V6N | 5 | DI | Vertical transfer clock 6 input |
| DVDD | 6 | P | Digital power supply |
| V5BN | 7 | DI | Vertical transfer clock 5B input |
| CH5N | 8 | DI | Read out clock 5 input |
| CH1N | 9 | DI | Read out clock 1 input |
| V1N | 10 | DI | Vertical transfer clock 1 input |
| CH2N | 11 | DI | Read out clock 2 input |
| V3AN | 12 | DI | Vertical transfer clock 3A input |
| V5AN | 13 | DI | Vertical transfer clock 5A input |
| CH3N | 14 | DI | Read out clock 3 input |
| GND | 15 | P | Ground |
| V3BN | 16 | DI | Vertical transfer clock 3B input |
| CH4N | 17 | DI | Read out clock 4 input |
| VL | 18 | P | Digital power supply |
| V3B | 19 | DO | Vertical transfer clock 3B output |
| V5A | 20 | DO | Vertical transfer clock 5A output |
| V3A | 21 | DO | Vertical transfer clock 3A output |
| V1 | 22 | DO | Vertical transfer clock 1 output |
| VH | 23 | P | Digital power supply |
| V5B | 24 | DO | Vertical transfer clock 5B output |
| V6 | 25 | DO | Vertical transfer clock 6 output |
| V4 | 26 | DO | Vertical transfer clock 4 output |
| V2 | 27 | DO | Vertical transfer clock 2 output |
| SUB | 28 | DO | CCD substrate clock SUB output |
| GND | P | Ground |  |
| GND | 30 | P | Ground |
|  |  |  |  |

FUNCTIONAL BLOCK DIAGRAM


## SWITCHING WAVEFORM



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## LOADING DIAGRAM

| Vertical clock series resistor | R1, R2, R4, R6 | $60 \Omega$ |
| :---: | :---: | :---: |
|  | R3A, R5A | $240 \Omega$ |
|  | R3B, R5B | $80 \Omega$ |
| Vertical clock to GND | C¢V1 | 1280 pF |
|  | CФVЗА, СФVЗВ | 640 pF |
|  | CФV5A, C¢V5B | 640 pF |
|  | СФV2, СФV4, СФV6 | 400 pF |
| Between vertical clock | C¢V12 | 510 pF |
|  | CФV23A, CФV23B | 50 pF |
|  | CФV45A, CФV45B | 50 pF |
|  | CФV3A4, CФV3B4 | 260 pF |
|  | CФV5A6, CФV5B6 | 260 pF |
|  | C¢V61 | 100 pF |
| Substrate clock to GND | CФVSUB | 1000 pF |
| Vertical clock GND resistor | R GND | $18 \Omega$ |



Figure 1. VSP1900 Loading Diagram

## DESCRIPTION

The VSP1900 is a CCD vertical clock driver with electric shutter. The VSP1900 is composed of five 3-state and three 2-state vertical transfer channels, which support both 3 field and 2 field CCD operation. The VSP1900 contributes low power consumption and parts number reduction in the system.

## OPERATION

## Power On/Off Sequence

This is the same as the CCD power up sequence, when power on, VDD powers on first VH, VM power on second, and VL powers on later. When powering off, VL powers off first, VH, VM power of second, and VDD powers off later.

## Vertical Transfer Signal

The VSP1900 receives signals from TG (CCD timing generator). The input signal is converted into CCD operation voltage level by the level shifter. The level shifter circuits connect to a 2 -state or 3-state driver, which is connected to the CCD input pin. While using a 2 -field CCD, one of the 3 -state drivers is used as a 2 -state driver. The CH\#N pin is pulled up internally, so that the VH level does not appear on the output pin.


Figure 2. FVSP1900 Circuit Application

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## MECHANICAL DATA

DBT (R-PDSO-G**)


| PIM | $\mathbf{2 0}$ | $\mathbf{2 4}$ | $\mathbf{2 8}$ | $\mathbf{3 0}$ | $\mathbf{3 8}$ | $\mathbf{4 4}$ | $\mathbf{5 0}$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| A MAX | 5,10 | 6,60 | 7,90 | 7,90 | 9,80 | 11,10 | 12,60 |
| A MIN | 4.90 | 6,40 | 7,70 | 7,70 | 9,60 | 10,90 | 12,40 |

NOTES: A. All linear dimensions are in millimeters.
B. This drawing is subject to change without notice.
C. Body dimensions do not include mold flash or protrusion.
D. Falls within JEDEC MO-153


| PIM | $\mathbf{2 0}$ | $\mathbf{2 4}$ | $\mathbf{2 8}$ | $\mathbf{3 0}$ | $\mathbf{3 8}$ | $\mathbf{4 4}$ | $\mathbf{5 0}$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| A MAX | 5,10 | 6,60 | 7,90 | 7,90 | 9,80 | 11,10 | 12,60 |
| A MIN | 4.90 | 6,40 | 7,70 | 7,70 | 9,60 | 10,90 | 12,40 |

NOTES: A. All linear dimensions are in millimeters.
B. This drawing is subject to change without notice.
C. Body dimensions do not include mold flash or protrusion.
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